NTS260ESF, NRVTS260ESF

Very Low Forward Voltage **Trench-based Schottky Rectifier**

Features

- Fine Lithography Trench–based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 11.7 mg (Approximately)
- JEFOR INF • Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Maximum for 10 Seconds
- MSL 1

Typical Applications

- Switching Power Supplies including Compact Adapters and Flat Panel Display
- High Frequency and DC-DC Converte
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

ON Semiconductor®

www.onsemi.com

TRENCH SCHOTTKY RECTIFIER 2.0 AMPERES 60 VOLTS

> SOD-123FL **CASE 498**

MARKING DIAGRAM



- AAC = Specific Device Code Μ
 - = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NTS260ESFT3G	SOD-123FL (Pb-Free)	10,000/ Tape & Reel
NRVTS260ESFT3G	SOD-123FL (Pb-Free)	10,000/ Tape & Reel
NTS260ESFT1G	SOD-123FL (Pb-Free)	3,000/ Tape & Reel
NRVTS260ESFT1G	SOD-123FL (Pb-Free)	3,000/ Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NTS260ESF, NRVTS260ESF

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	V
Average Rectified Forward Current $(T_L = 128^{\circ}C)$	Ι _Ο	2.0	A
Peak Repetitive Forward Current (Square Wave, 20 kHz, T _L = 137°C)	I _{FRM}	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	50	A
Storage and Operating Junction Temperature Range (Note 1)	T _{stg} , T _J	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from

Junction–to–Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS

Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$. THERMAL CHARACTERISTICS		-SIGN	2
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 2)	Ψ_{JCL}	24.4	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	R _{0JA}	85	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3)	R _{θJA}	330	°C/W
ELECTRICAL CHARACTERISTICS	Sel), _	

ELECTRICAL CHARACTERISTICS

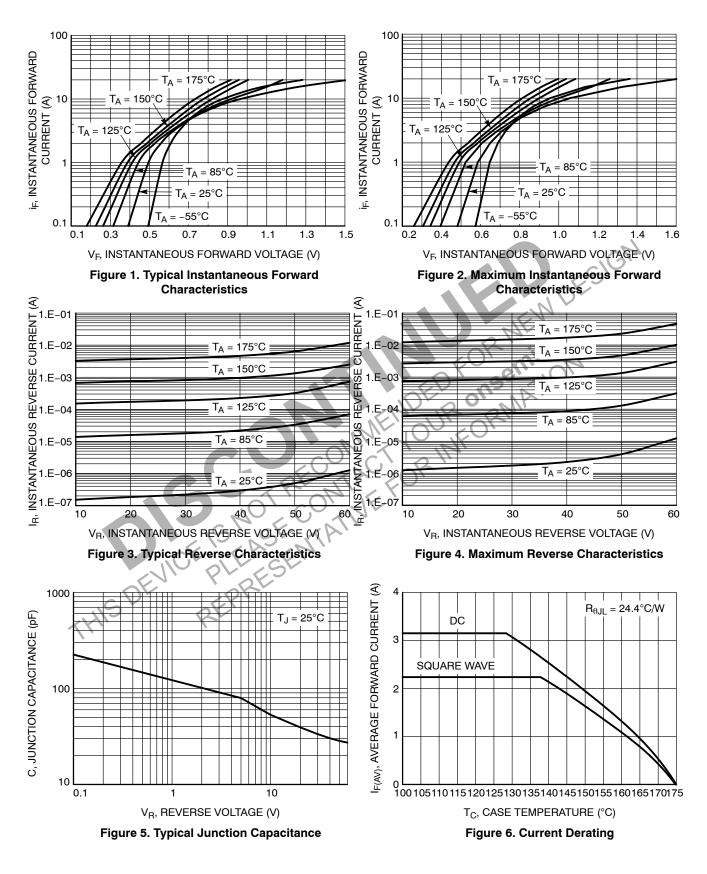
Characteristic	bol Value	Unit
Maximum Instantaneous Forward Voltage (Note 4) $(I_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C})$ $(I_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C})$ $(I_F = 1.0 \text{ A}, T_J = 125^{\circ}\text{C})$ $(I_F = 2.0 \text{ A}, T_J = 125^{\circ}\text{C})$	F 0.55 0.65 0.47 0.58	V
Maximum Instantaneous Reverse Current (Note 4) (Rated dc Voltage, $T_J = 25^{\circ}$ C) (Rated dc Voltage, $T_J = 125^{\circ}$ C)If	3 12 3	μA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics for the listed test conditions. 2. Mounted with 700 mm² copper pad size (Approximately 1 in²) 1 oz FR4 Board. 3. Mounted with pad size approximately 20 mm² copper, 1 oz FR4 Board. 4. Pulse Test: Pulse Width \leq 380 µs, Duty Cycle \leq 2.0%.

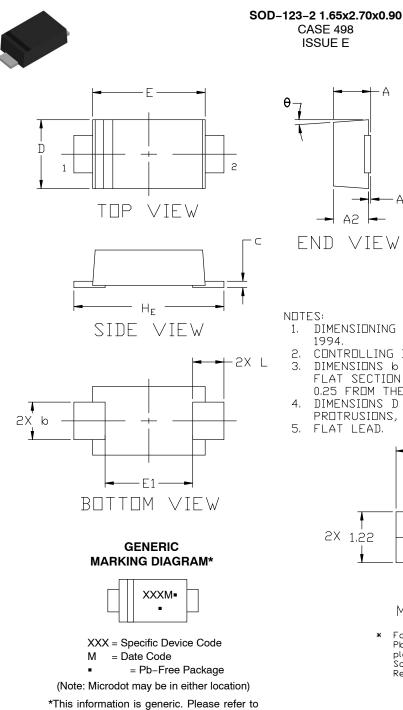
- THISD

NTS260ESF, NRVTS260ESF

TYPICAL CHARACTERISTICS







device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may

not follow the Generic Marking.

MILLIMETERS DIM MIN. NDM. MAX. 0.90 0.95 0.98 А A1 0.00 0.05 0.10 Α2 0.85 0.90 0.95 0.70 0.90 1.10 b С 0.10 0.15 0.20 D 1.50 1.65 1.80 Е 2.50 2.70 2.90 Ε1 1.70 2.10 2.50 Η_E 3.40 3.60 3.80 0.55 0.75 0.95 L θ 0° ____ 8°

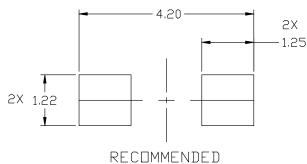
DATE 22 AUG 2023

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M,
- CONTROLLING DIMENSION: MILLIMETERS

А

- Δ1

- DIMENSIONS 6 AND L ARE TO BE MEASURED ON A FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 FROM THE LEAD TIP.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH PROTRUSIONS, OR GATE BURRS.
- 5. FLAT LEAD.



MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON11184D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	SOD-123-2 1.65x2.70x0.90	DD-123-2 1.65x2.70x0.90	

DNSEM). are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>